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(12) **United States Design Patent** (10) **Patent No.:** **US D967,031 S**
Musser et al. (45) **Date of Patent:** **** Oct. 18, 2022**

(54) **ELECTRICAL CABLE CONNECTOR**

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(**) Term: **15 Years**

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(21) Appl. No.: **29/746,140**

(57) **CLAIM**

(22) Filed: **Aug. 12, 2020**

The ornamental design for an electrical cable connector, as shown and described.

DESCRIPTION

Related U.S. Application Data

(62) Division of application No. 29/632,520, filed on Jan. 8, 2018, now Pat. No. Des. 896,183.

(51) **LOC (13) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/147**

(58) **Field of Classification Search**
USPC D13/146, 147, 123, 133, 137.1–139.8, D13/154
CPC H01R 9/223; H01R 9/2491; H01R 12/721; H01R 13/6585

See application file for complete search history.

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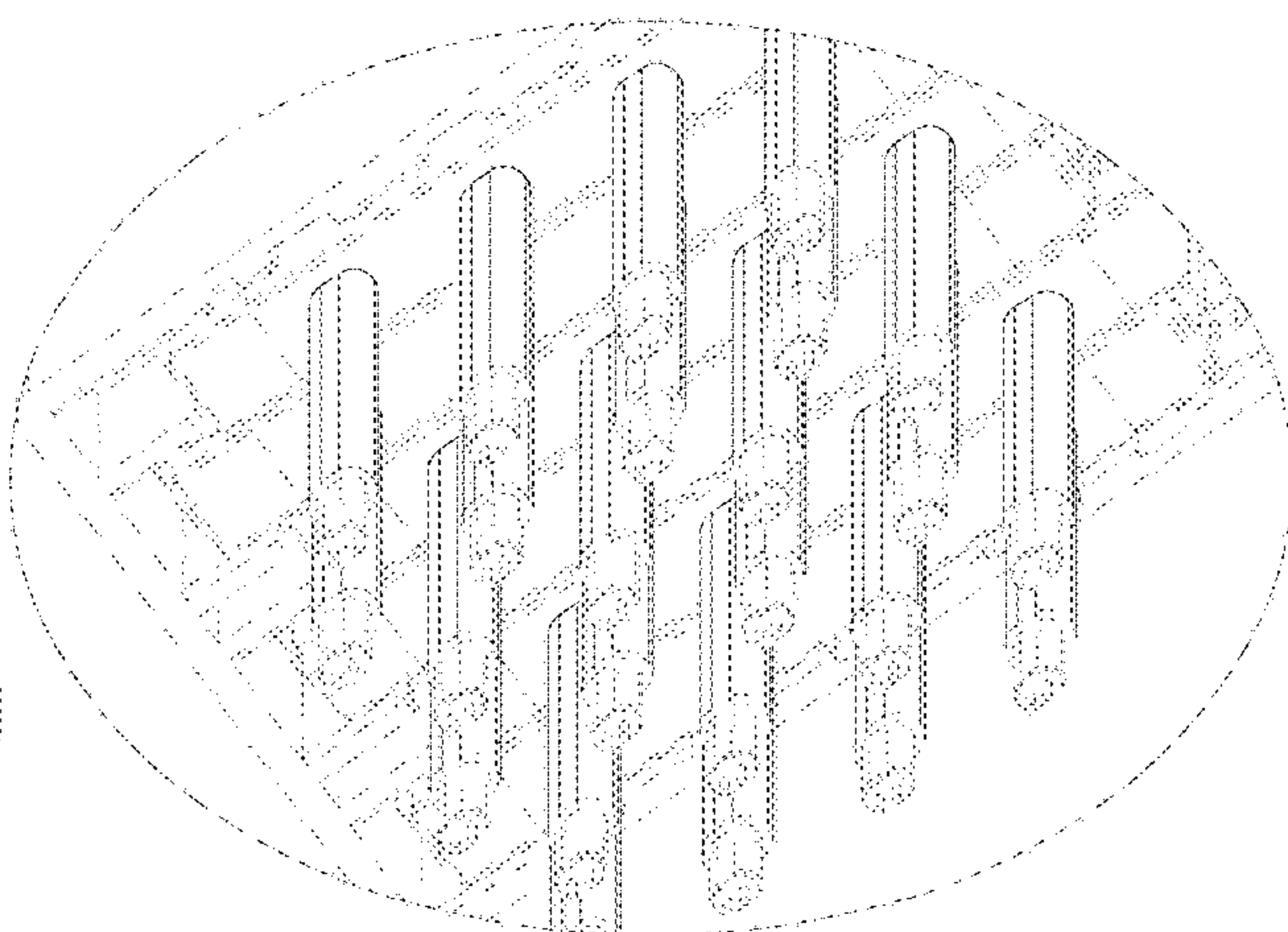
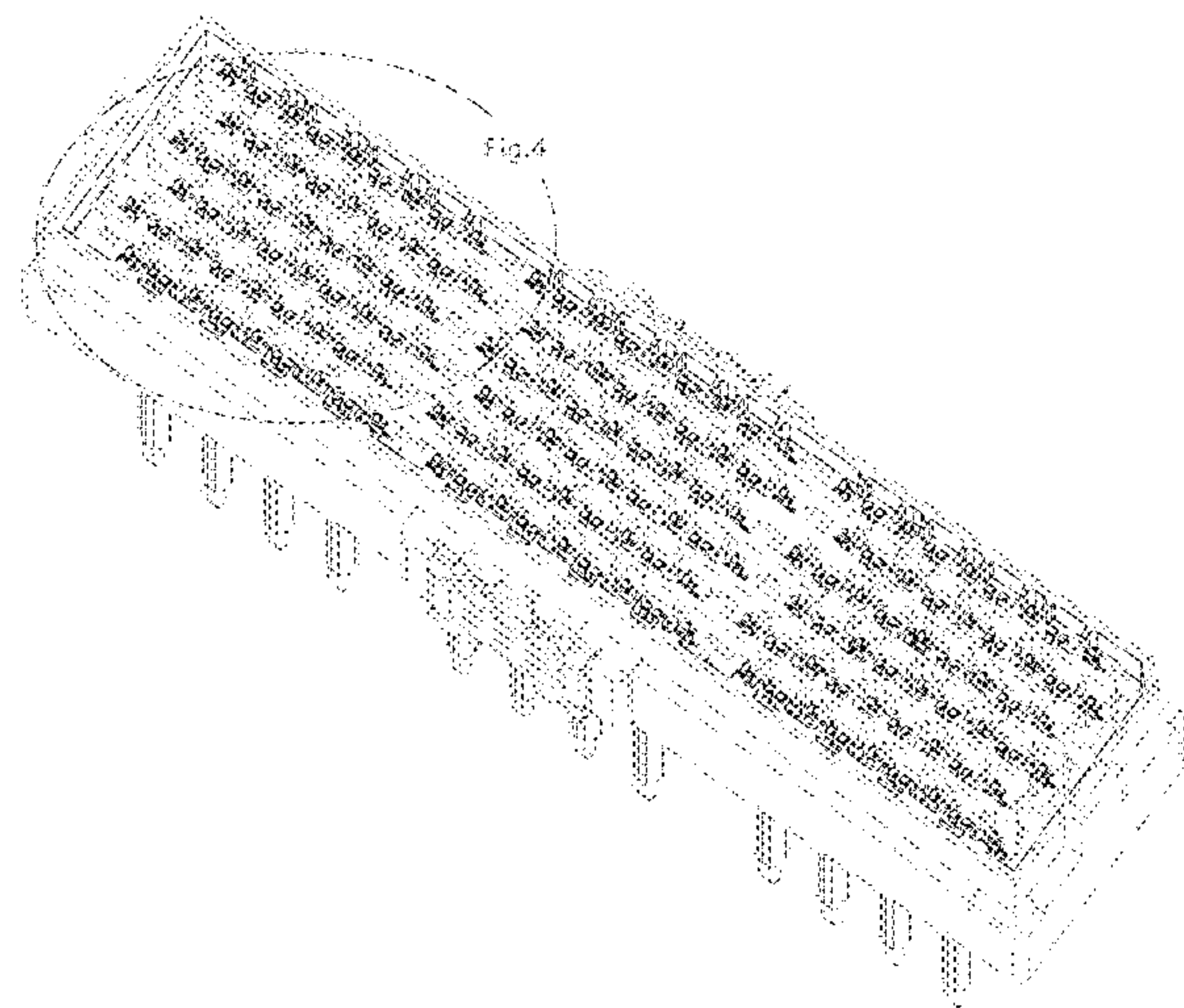
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FIG. 1 is a top, front, right perspective view of an electrical cable connector according to our new design; FIG. 2 is a bottom, rear, left perspective view thereof; FIG. 3 is another top, front, right perspective view thereof; FIG. 4 is an enlarged top, front, right perspective view of the portion indicated at region FIG. 4 of FIG. 3; FIG. 5 is another bottom, rear, left perspective view thereof; FIG. 6 is an enlarged bottom, rear, left perspective view of the portion indicated at region FIG. 6 of FIG. 5; FIG. 7 is a top plan view thereof; FIG. 8 is a bottom plan view thereof; FIG. 9 is a left side elevation view thereof; FIG. 10 is a right side elevation view thereof; FIG. 11 is a front elevation view thereof; and, FIG. 12 is a rear elevation view thereof.

The broken line portion of the figure drawings is included to show unclaimed subject matter only for the purpose of illustrating environment and forms no part of the claimed. In addition, the surfaces in the views between the claimed solid line edges and the broken lines form no part of the claimed design.

1 Claim, 9 Drawing Sheets



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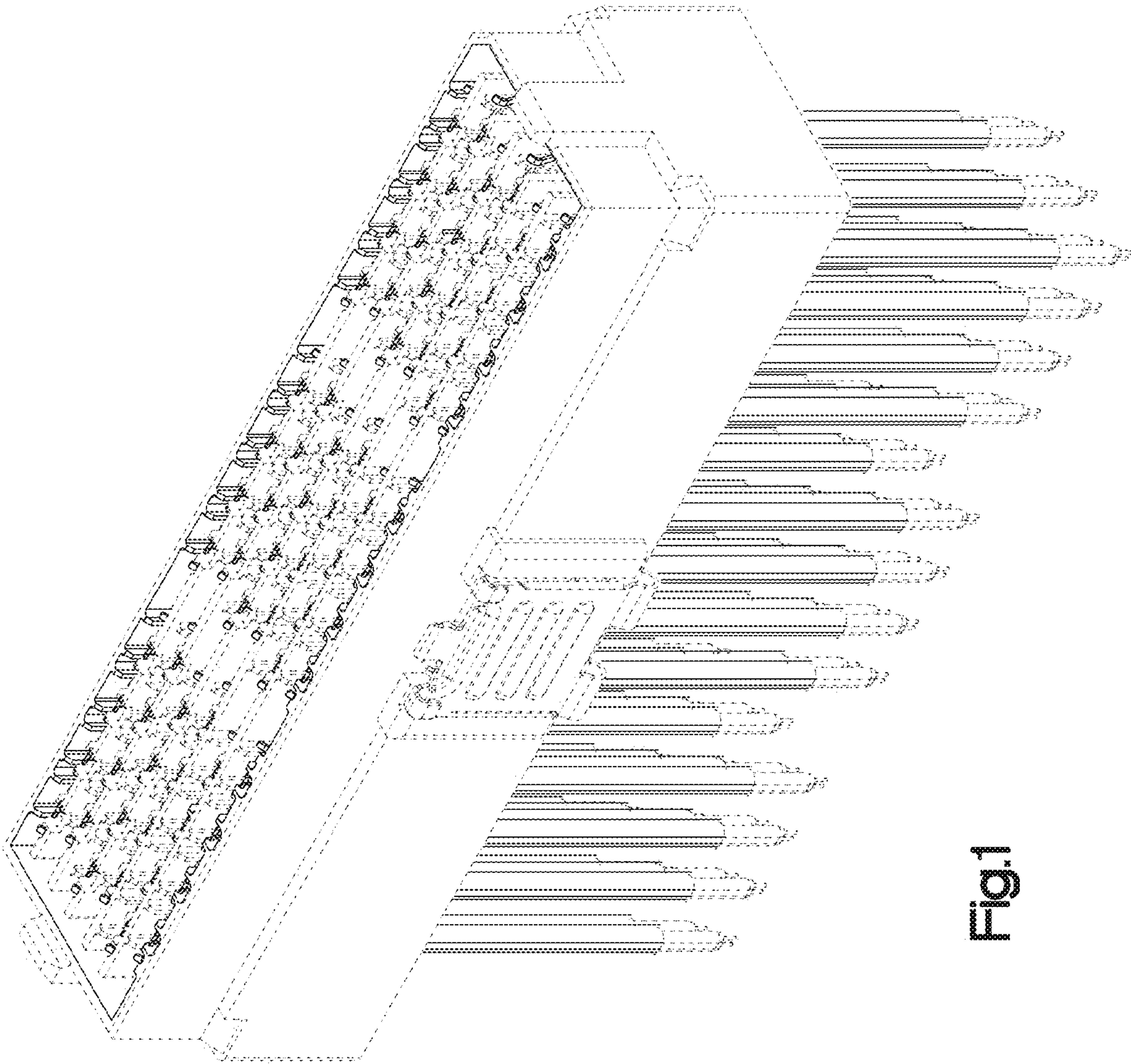


Fig. 1

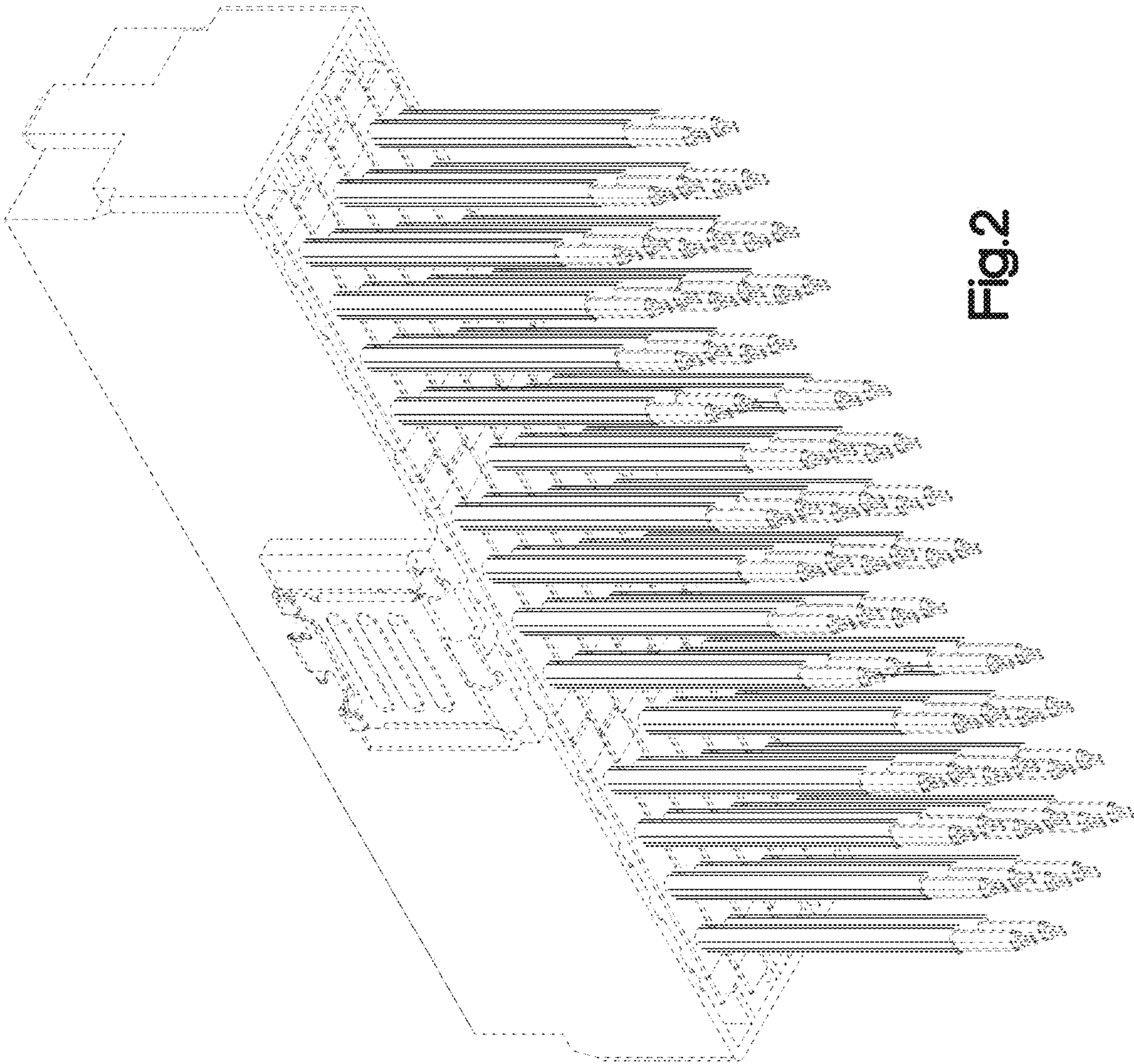
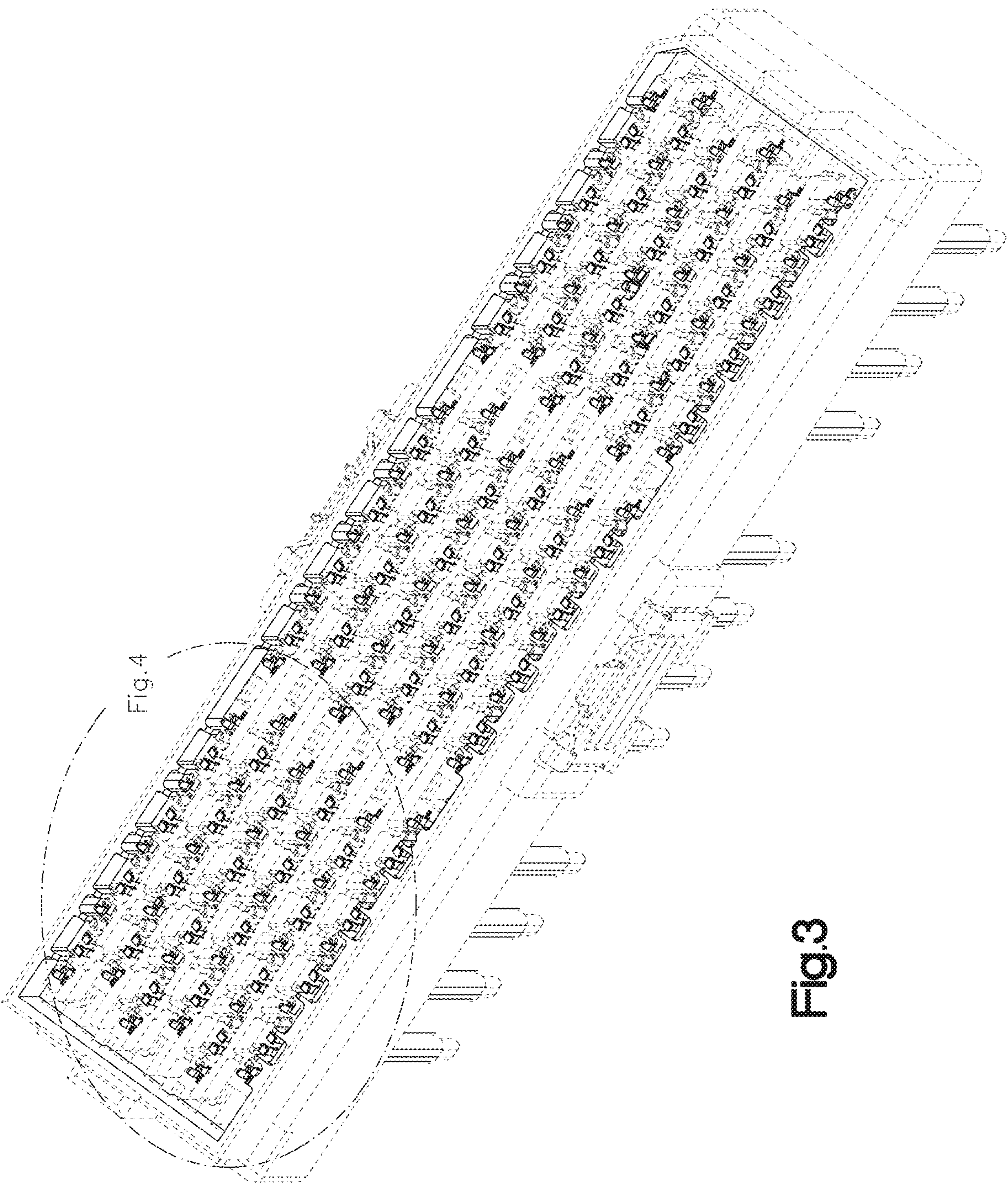


Fig.2



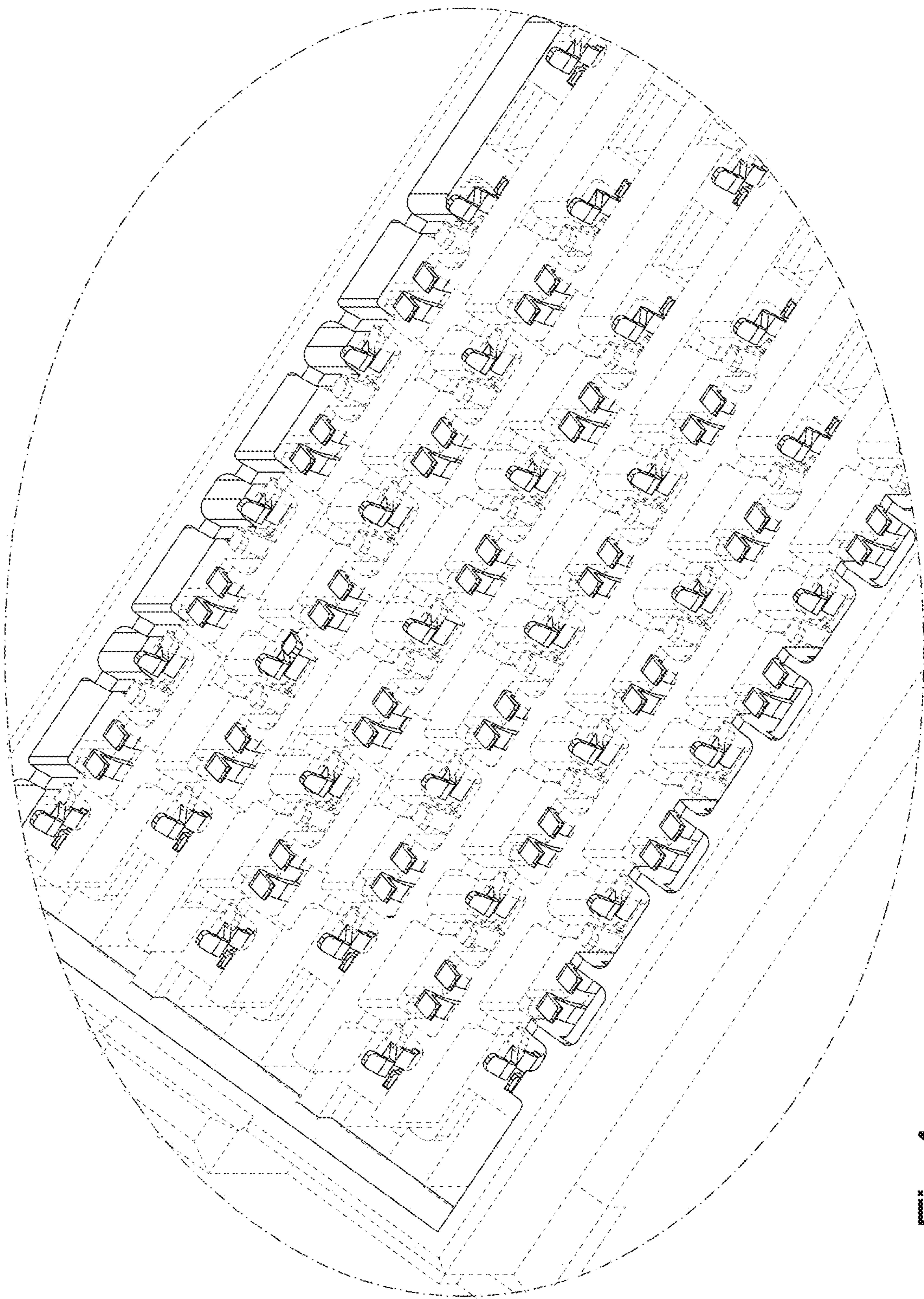
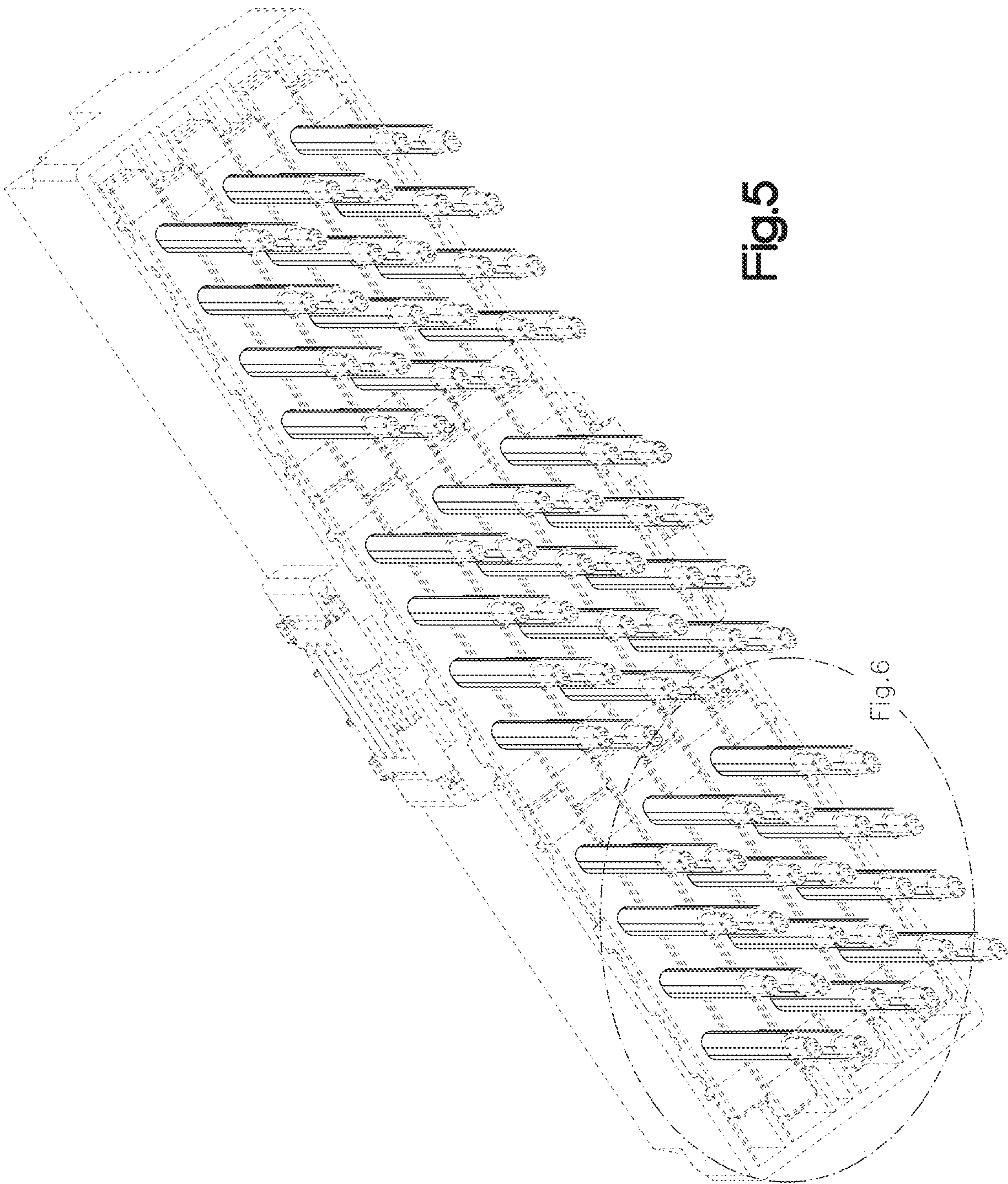


Fig.4



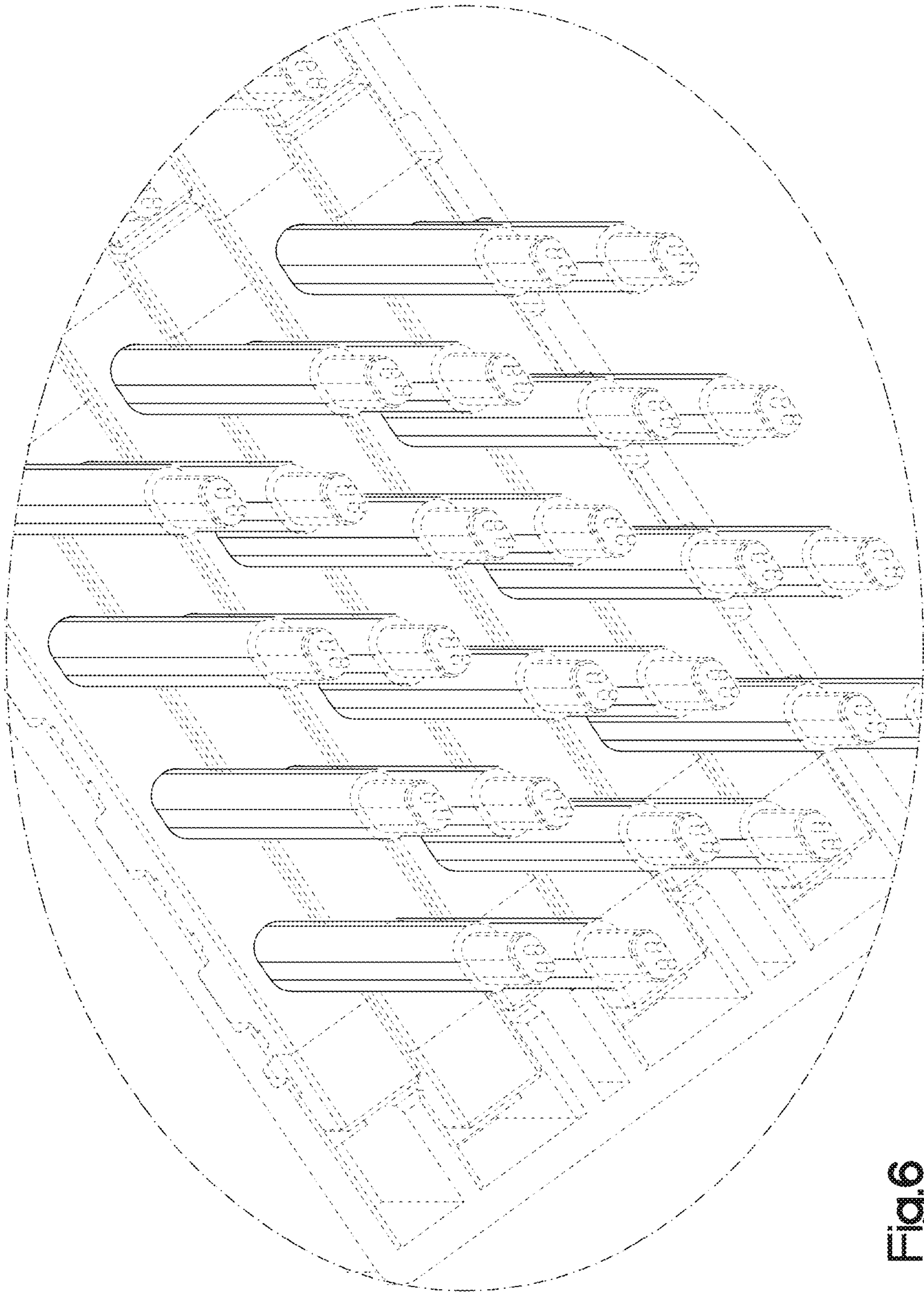


Fig. 6

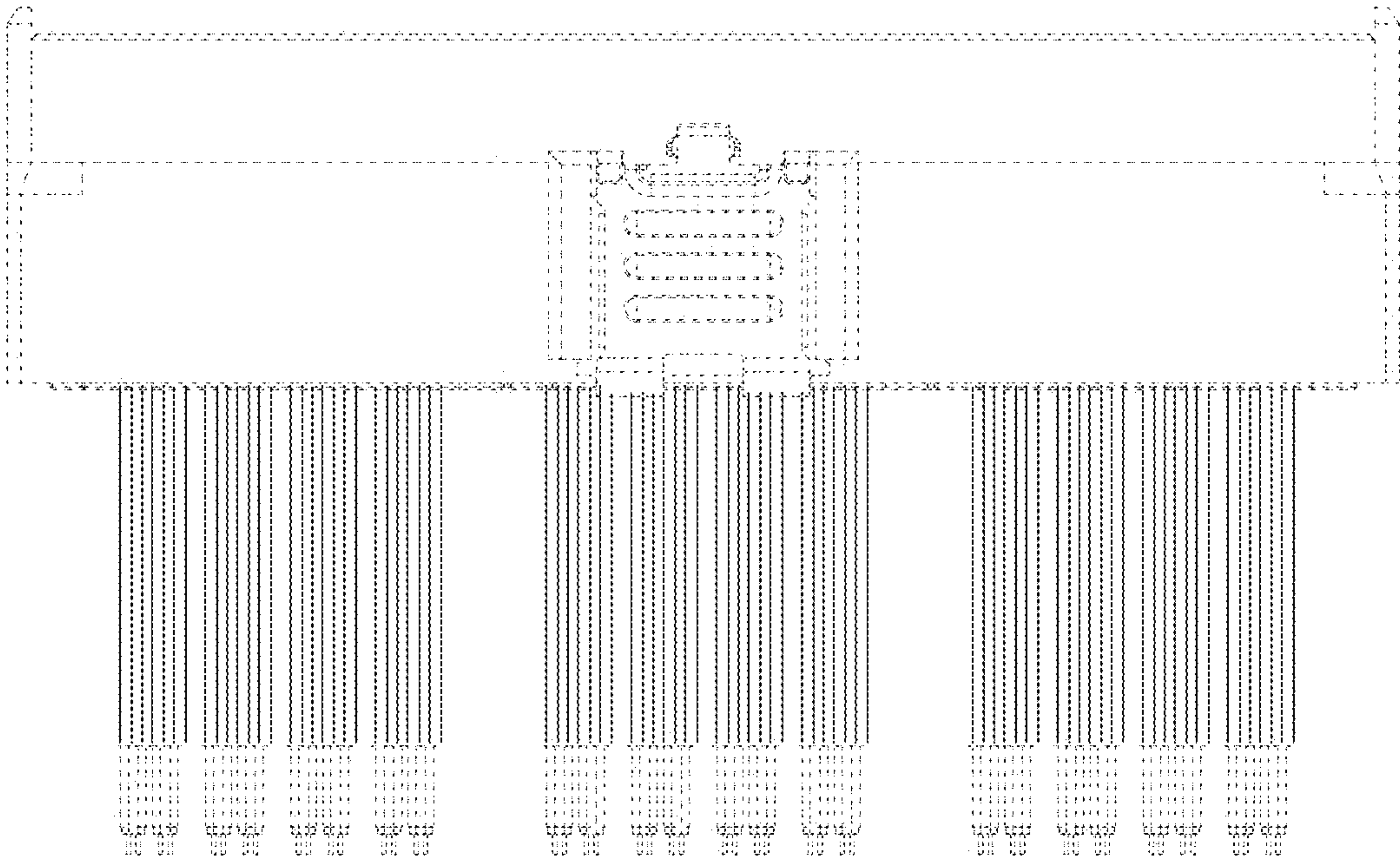


Fig.7

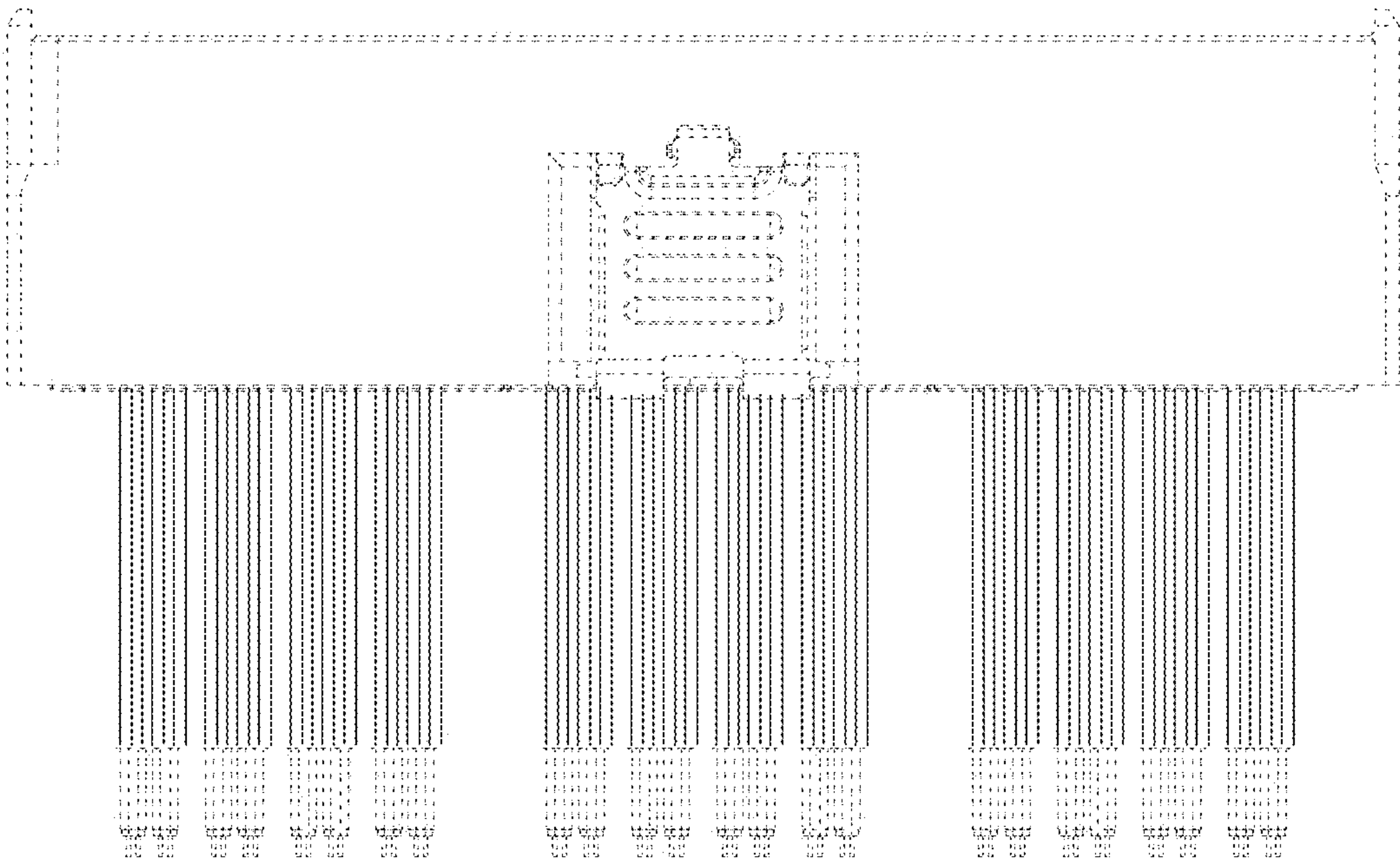


Fig.8

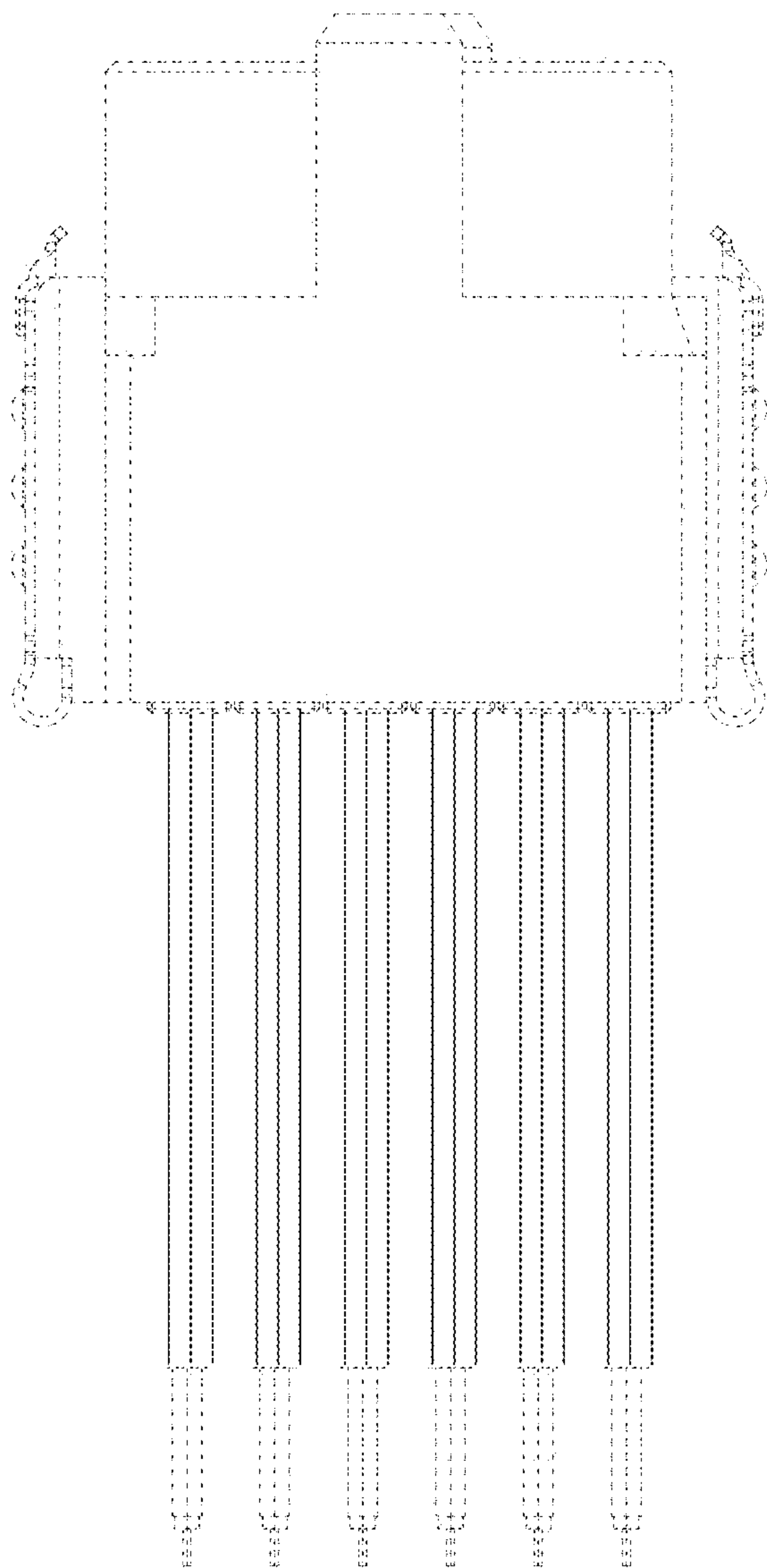


Fig.9

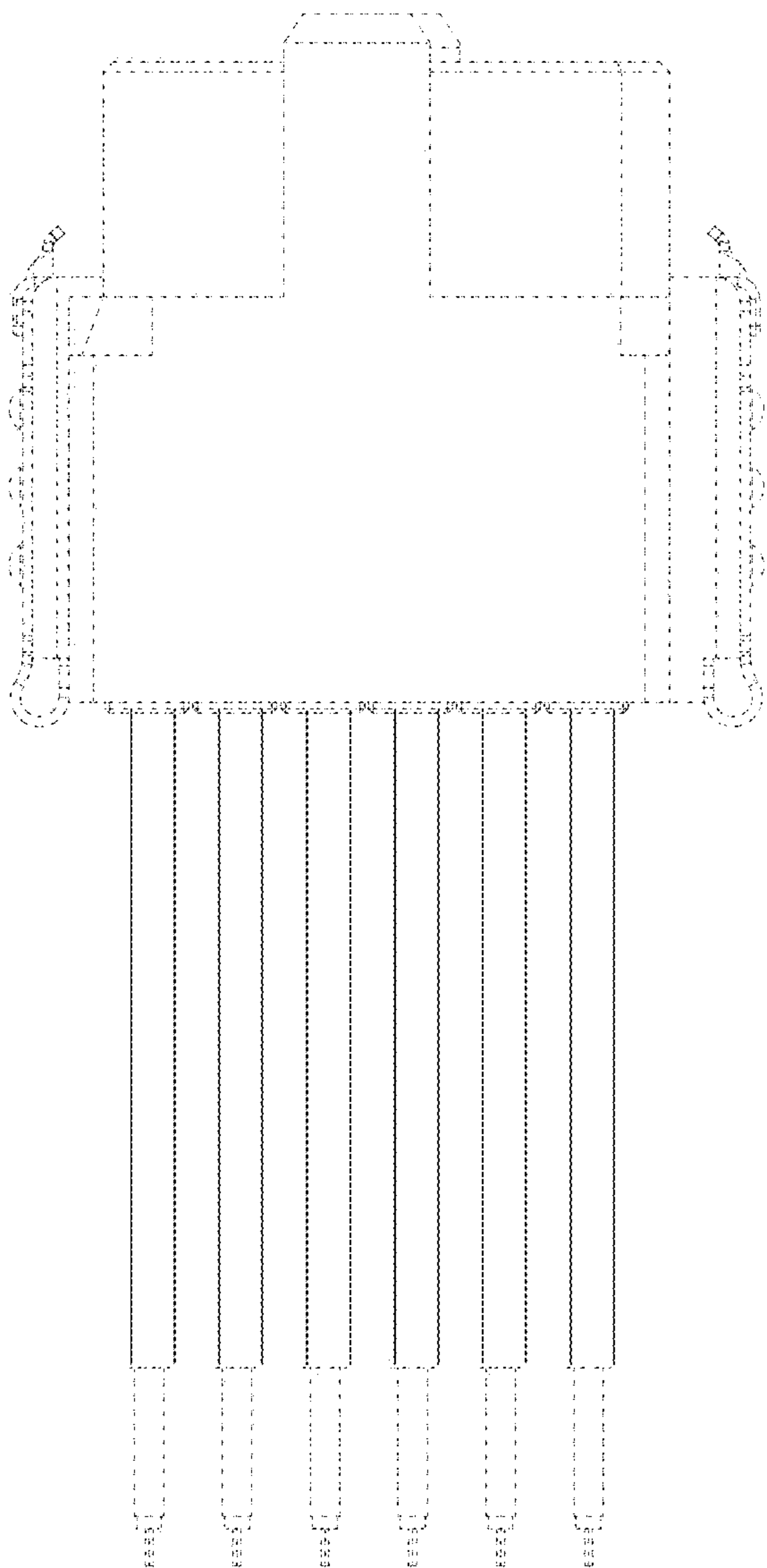


Fig.10

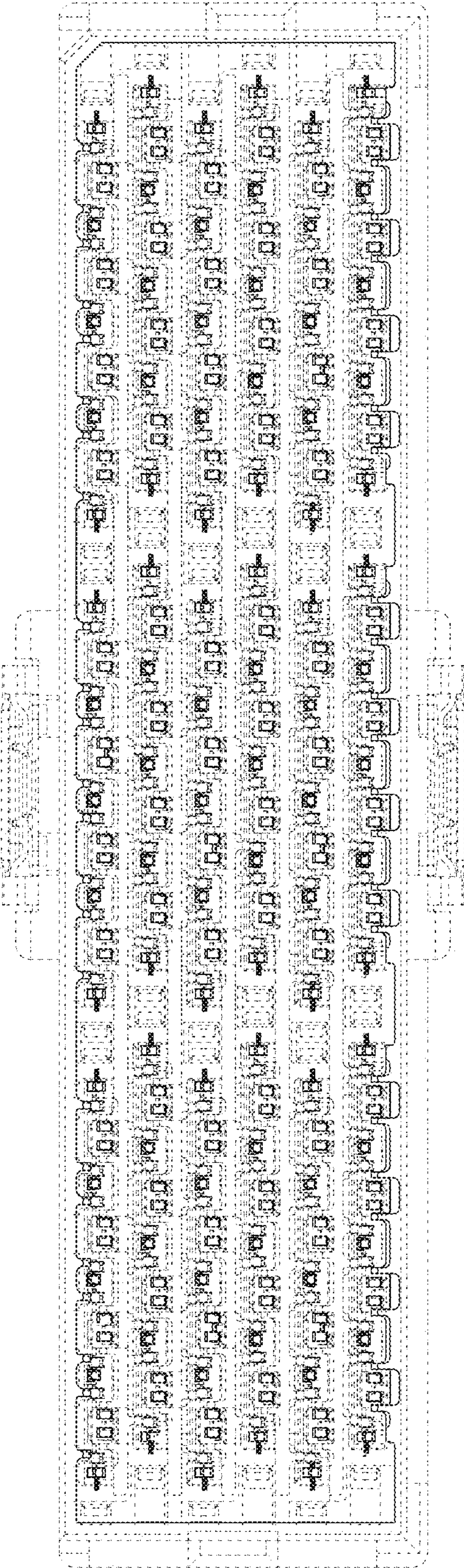


Fig.11

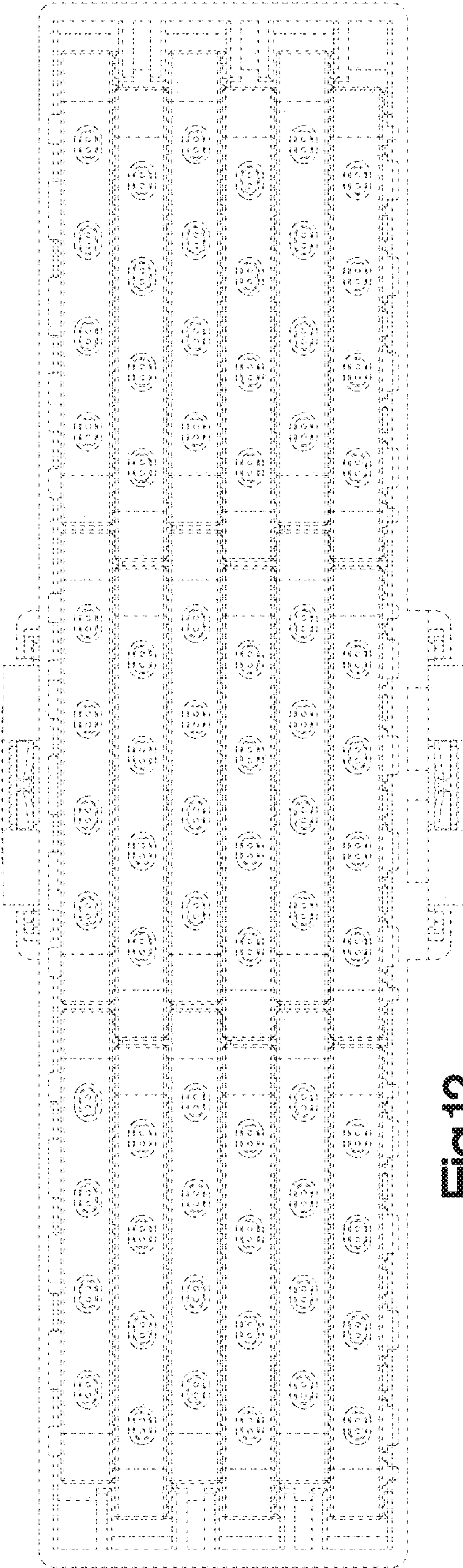


Fig.12